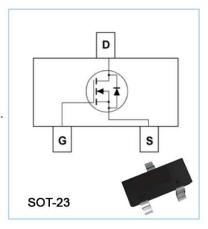




N-Channel Enhancement Mode MOSFET

Feature

- 50V/0.2A, $R_{DS(ON)} = 3.5 \Omega (MAX)$ @ $V_{GS} = 5V$. Id = 0.2A $R_{DS(ON)} = 10 \Omega (MAX)$ @ $V_{GS} = 2.75V$. Id = 0.2A
- Super High dense cell design for extremely low RDS(ON).
- Reliable and Rugged.
- Low Threshold Voltage (0.5V—1.5V) Make it Ideal for Low Voltage Applications.
- SOT-23 for Surface Mount Package.



Applications

Power Management in DC/DC Converters. Portable and Battery-powered Products.

Absolute Maximum Ratings

TA=25°C Unless Otherwise noted

Parameter	Symbol	Limit	Units
Drain-Source Voltage	V_{DS}	50	V
Gate-Source Voltage	V_{GS}	±20	V
Drain Current-Continuous	I_D	0.2	Α

Electrical Characteristics

TA=25°C Unless Otherwise noted

Electrical Characteristics 1A=25 C Unless Otherwise noted								
Parameter	Symbol	Test Conditions	Min	Тур.	Max	Units		
Off Characteristics								
Drain to Source Breakdown Voltage	BVDSS	VGS=0V, ID=250μA	50	-	-	V		
Zero-Gate Voltage Drain Current	IDSS	VDS=50V, VGS=0V	-	-	0.5	μΑ		
		VDS=25V, VGS=0V	-	-	0.1			
Gate Body Leakage Current, Forward	IGSSF	VGS=20V, VDS=0V	-	-	100	nA		
Gate Body Leakage Current, Reverse	IGSSR	VGS=-20V, VDS=0V	-	-	-100	nA		
On Characteristics								
Gate Threshold Voltage	VGS(th)	VGS= VDS, ID=1.0 mA	0.5	-	1.5	V		
Static Drain-source	RDS(ON)	VGS =5.0V, ID =0.2A	-	-	3.5	Ω		
On-Resistance		VGS =2.75V, ID =0.2A	-	-	10	Ω		
Drain-Source Diode Characteristics and Maximum Ratings								
Drain-Source Diode Forward Voltage	VSD	VGS =0V, IS=0.2A			2.5	V		

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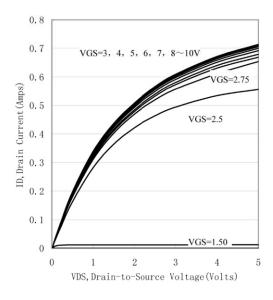
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Typical Characteristics



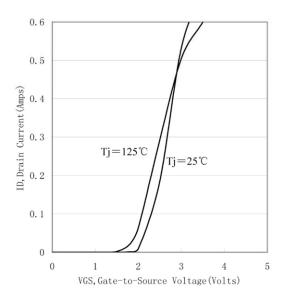


Figure 1. Output Characteristics

Figure 2. Transfer Characteristics

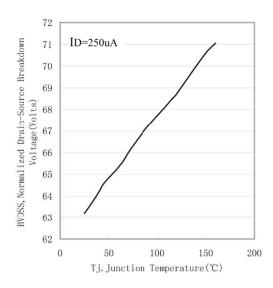


Figure 3. Breakdown Voltage Variation with Temperature

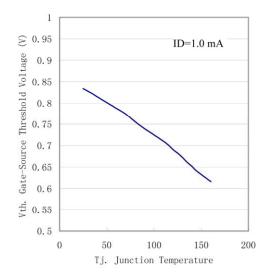


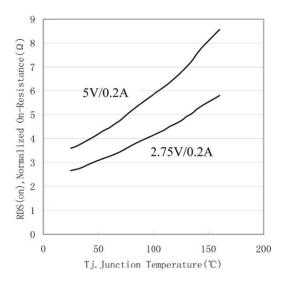
Figure 4. Gate Threshold Variation with Temperature

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Typical Characteristics

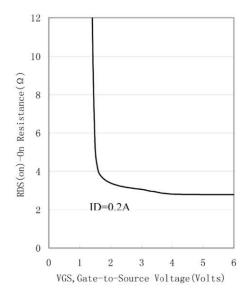


0 0 0.2 0.4 0.6 0.8 1

ID-Drain Current (A)

Figure 5. On-Resistance Variation with Temperature

Figure 6. On-Resistance vs. Drain Current



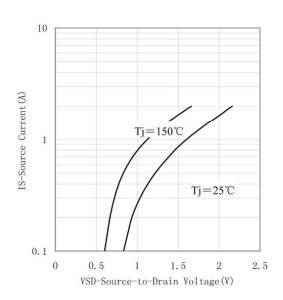


Figure 7. On-Resistance vs. Gate-to-Source Voltage

Figure 8. Source-Drain Diode Forward Voltage

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